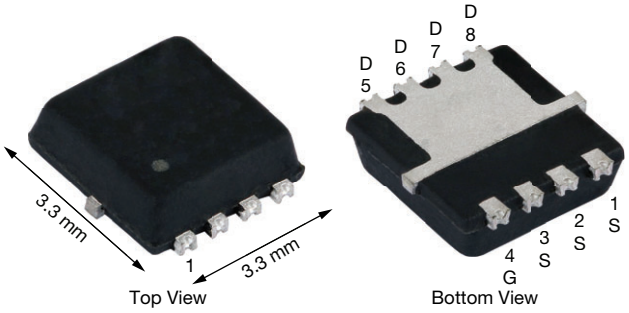
Automotive N-Channel 60 V (D-S) 175 °C MOSFET

PowerPAK® 1212-8W Single



FEATURES

- TrenchFET® power MOSFET
- Low thermal resistance PowerPAK® 1212-8 package with 1.07 mm profile
- PWM optimized
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Wettable flank terminals
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

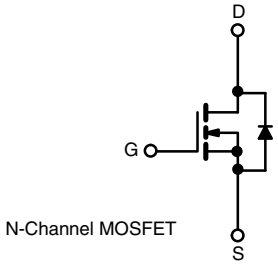
Pb-free

RoHS COMPLIANT

HALOGEN FREE

Marking Code: Q037

PRODUCT SUMMARY	
V_{DS} (V)	60
$R_{DS(on)}$ (Ω) at V_{GS} = 10 V	0.023
$R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V	0.028
I_D (A)	18
Configuration	Single
Package	PowerPAK 1212-8W



ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Drain-source voltage		V_{DS}	60	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current [a]	T_C = 25 °C	I_D	18	A
	T_C = 125 °C		18	
Continuous source current (diode conduction) [a]		I_S	18	
Pulsed drain current [b]		I_{DM}	72	
Single pulse avalanche current	L = 0.1 mH	I_{AS}	20	
Single pulse avalanche energy		E_{AS}	16	mJ
Maximum power dissipation [b]	T_C = 25 °C	P_D	62	W
	T_C = 125 °C		20	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) [d]			260	

THERMAL RESISTANCE RATINGS				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Junction-to-ambient	PCB mount [c]	R_{thJA}	81	°C/W
Junction-to-case (drain)		R_{thJC}	2.4	

Notes

a. Package limited
b. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
c. When mounted on 1" square PCB (FR4 material)
d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

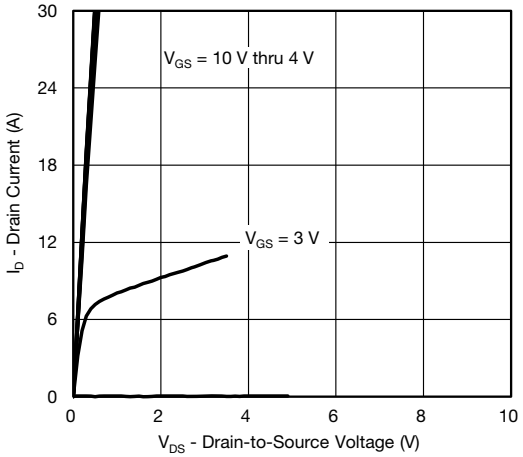
SPECIFICATIONS (T_C = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static							
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA		60	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA		1.5	2	2.5	
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V		-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{GS} = 0 V	V_{DS} = 60 V	-	-	1	µA
		V_{GS} = 0 V	V_{DS} = 60 V, T_J = 125 °C	-	-	50	
		V_{GS} = 0 V	V_{DS} = 60 V, T_J = 175 °C	-	-	150	
On-state drain current [a]	$I_{D(on)}$	V_{GS} = 10 V	V_{DS} ≥ 5 V	20	-	-	A
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V	I_D = 8.7 A	-	0.016	0.023	Ω
		V_{GS} = 10 V	I_D = 8.7 A, T_J = 125 °C	-	-	0.039	
		V_{GS} = 10 V	I_D = 8.7 A, T_J = 175 °C	-	-	0.050	
		V_{GS} = 4.5 V	I_D = 8.7 A	-	0.019	0.028	
Forward transconductance [b]	g_{fs}	V_{DS} = 15 V, I_D = 8.7 A		-	50	-	S
Dynamic [b]							
Input capacitance	C_{iss}	V_{GS} = 0 V	V_{DS} = 30 V, f = 1 MHz	-	1275	1590	pF
Output capacitance	C_{oss}			-	112	140	
Reverse transfer capacitance	C_{rss}			-	42	52	
Total gate charge [c]	Q_g	V_{GS} = 10 V	V_{DS} = 30 V, I_D = 8.7 A	-	19	25	nC
Gate-source charge [c]	Q_{gs}			-	2.6	-	
Gate-drain charge [c]	Q_{gd}			-	3.6	-	
Gate resistance	R_g	f = 1 MHz		0.6	1.12	1.6	Ω
Turn-on delay time [c]	$t_{d(on)}$	V_{DD} = 30 V, R_L = 30 Ω I_D ≅ 1 A, V_{GEN} = 10 V, R_g = 1 Ω		-	8	10	ns
Rise time [c]	t_r			-	13	16	
Turn-off delay time [c]	$t_{d(off)}$			-	22	26	
Fall time [c]	t_f			-	15	18	
Source-Drain Diode Ratings and Characteristics [b]							
Pulsed current [a]	I_{SM}			-	-	72	A
Forward voltage	V_{SD}	I_F = 8.7 A, V_{GS} = 0 V		-	0.8	1.2	V

Notes

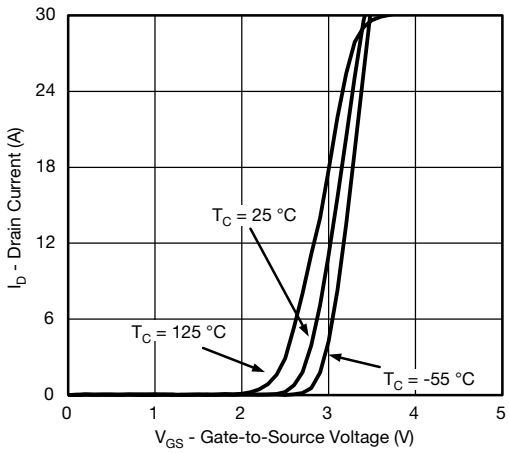
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

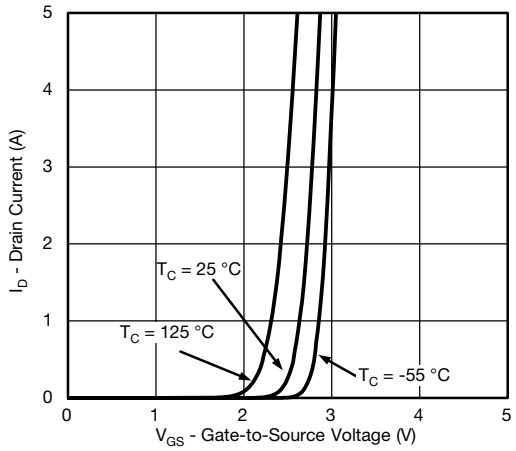
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



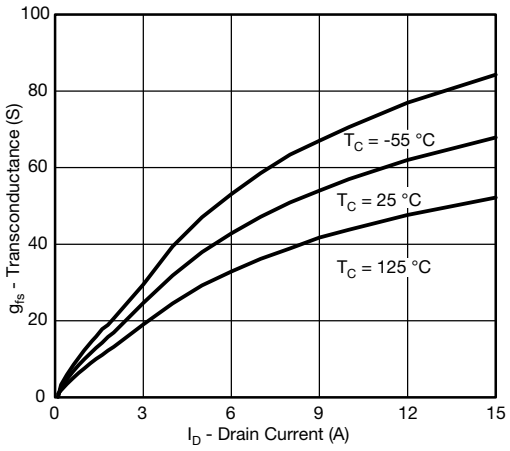
Output Characteristics



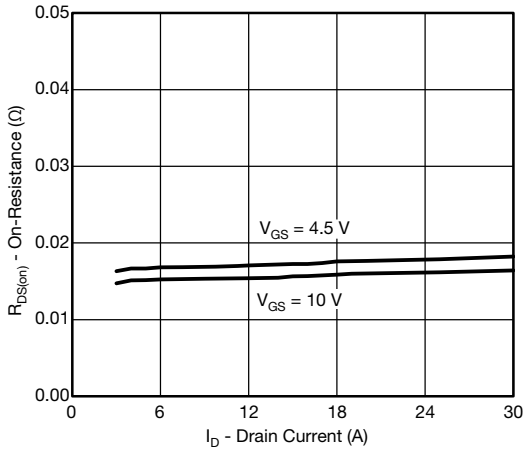
Transfer Characteristics



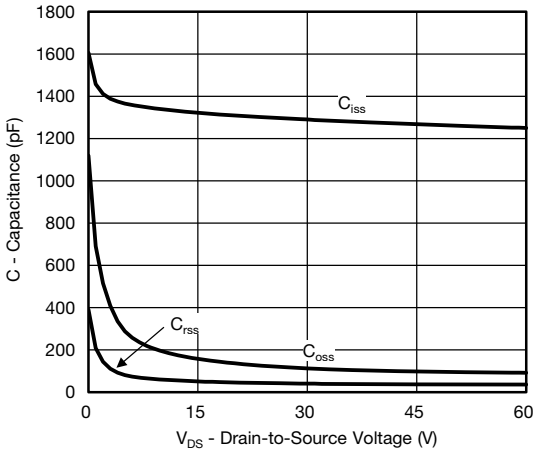
Transfer Characteristics



Transconductance

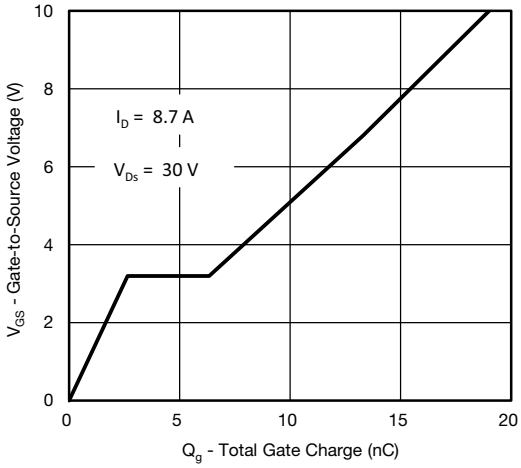


On-Resistance vs. Drain Current

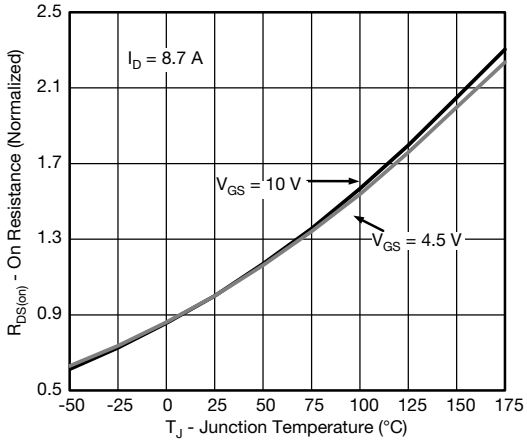


Capacitance

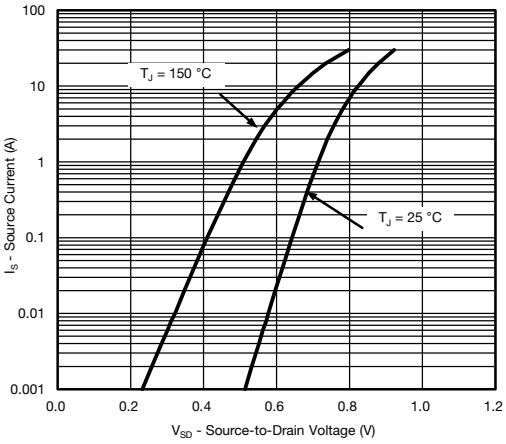
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



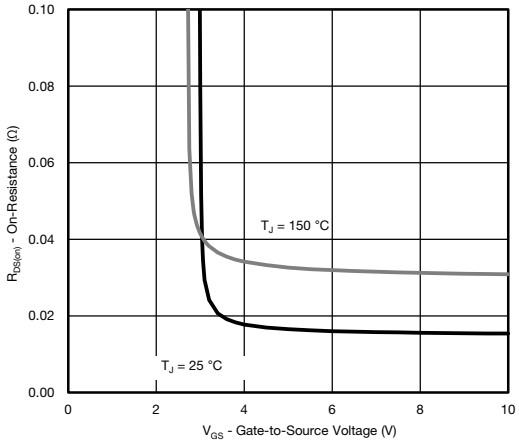
Gate Charge



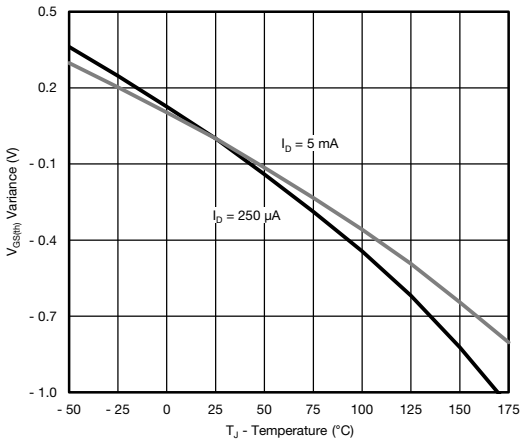
On-Resistance vs. Junction Temperature



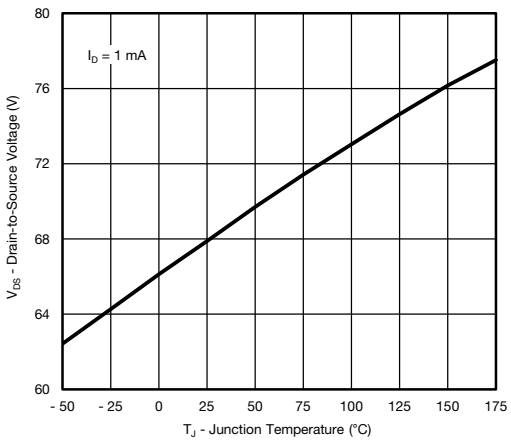
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

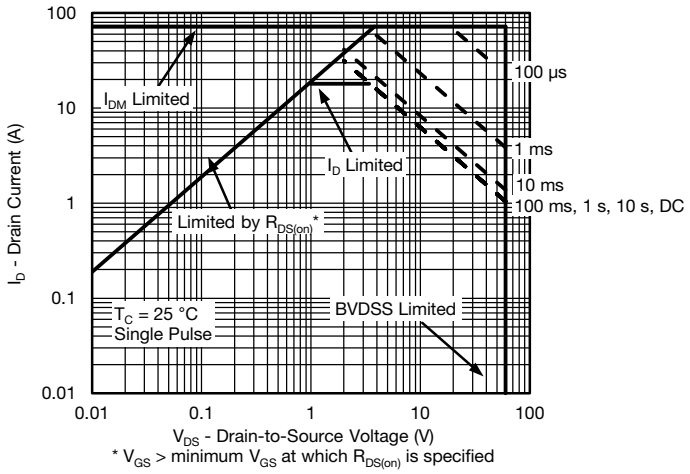


Threshold Voltage

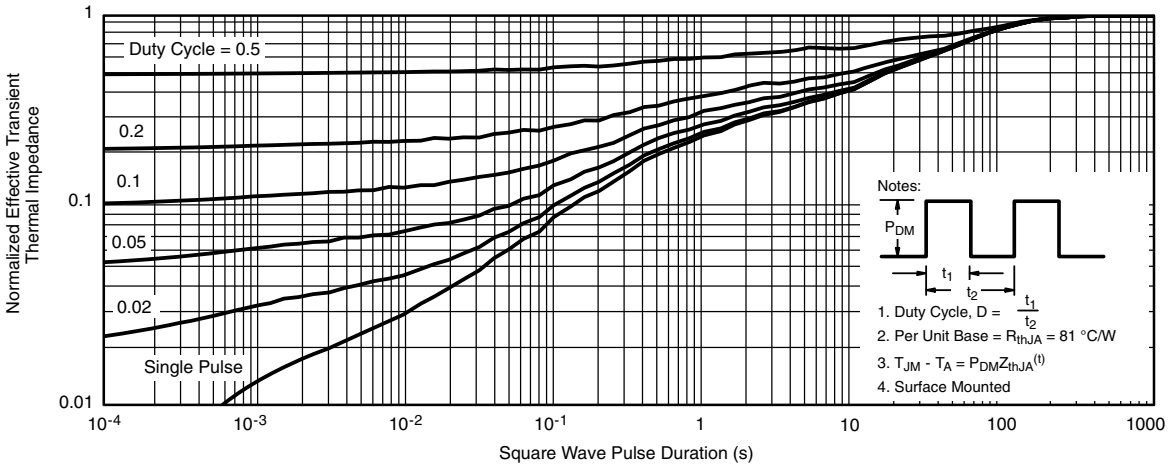


Drain Source Breakdown vs. Junction Temperature

THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)

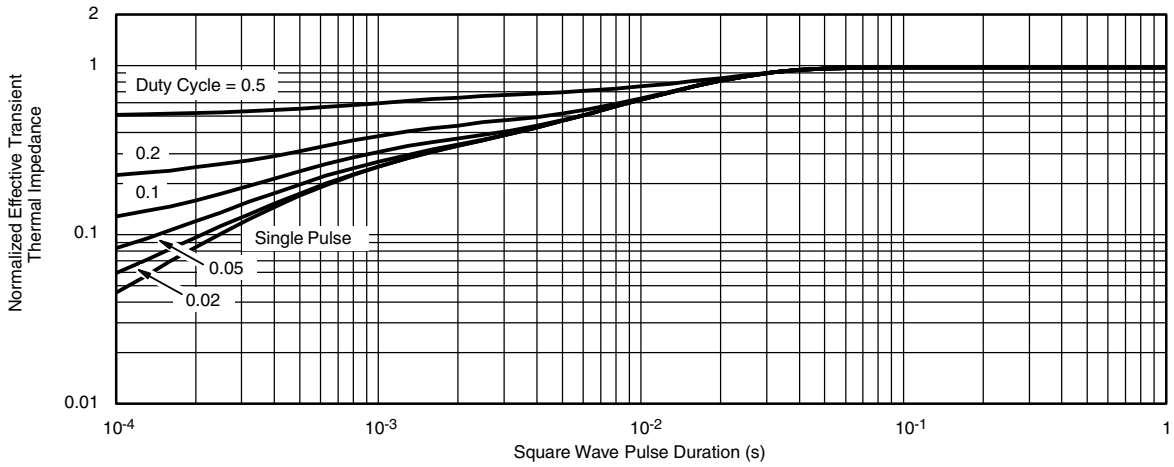


Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

  are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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